



ABOUT TJIT:

T. John Institute of Technology (TJIT) is a private Engineering College located in Bangalore, Karnataka, India. It was established in 2006 by Dr. Thomas John and is part of T. John Group of Institutions. The Institute offers Undergraduate & Postgraduate programmes, and is affiliated to Visvesvaraya Technological University (VTU) and is approved by All India Council for Technical Education (AICTE).

CHIEF PATRON:

Dr. Thomas John, Chairman
T. John Group of Institutions, Bengaluru

PATRON:

Dr. H. P. Srinivasa, Principal
T. John Institute of Technology, Bengaluru

CHAIR PERSON:

Dr. Drakshayini M N, HOD,
Department of Electronics & Communication
Engineering,
T. John Institute of Technology, Bengaluru

CONVENER:

Dr. Dhineshbabu N R, Associate Professor,
Department of Electronics & Communication
Engineering,
T. John Institute of Technology, Bengaluru

ORGANISING COMMITTEE:

Dr. V. Manjunatha	Dr. Parameshappa
Dr. V. R. Rajan	Dr. Poornima
Dr. D. Rene Dev	Dr. Srilatha B
Mrs. Aarthy J	Mrs. Aathira Arun Raj
Mrs. Sylvia R	Mr. Manjunathareddy K M

KEYNOTE SPEAKERS:



Mr. S. Sam Jaikumar
Manager (IP & Technology Transfer),
AICTE, Ministry of Education,
Govt. of India, Bengaluru



Ms. Reena Dev
Tech Manager,
Aspire Systems, United States

ABOUT THE DEPARTMENT:

The Department of Electronics & Communication Engineering was established at T. John Institute of Technology in 2006. Since its inception, the department has grown meteorically. The department seeks to excel as a technology hub processing research and educating students in current technological developments. It is equipped with the state-of-the-art infrastructure and supported by a team of dedicated and qualified Staff members. Our department's Faculty members bring state-of-the-art Research, Development, and design experience into the classroom, ensuring that our Students are able to apply and recognize as Professional Engineers in all part of global engineering and the technical community.

VISION:

To achieve Academic excellence in Electronics and Communication, related domains towards advanced technology through Knowledge transfer, Skill development, Value added trainings and Innovative practices for meeting global standards, societal needs and transforming students into potentially global leaders.

MISSION:

M1: To provide excellence in Education, Research and Skill development that caters to Global technological and social requirements.

M2: To develop skills for pursuing Innovation and Entrepreneurial ventures for graduating engineers to make the students entrepreneurs and employable.

M3: Initiate value added Professional collaborations with an Intellectual environment for the overall success.

OUR SPONSORS:



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Address: 86/1, Gottigere, Bannerghatta Road,
Bengaluru, Karnataka, India - 560 083

T. John Institute of Technology
proudly hosting

INTERNATIONAL CONFERENCE ON MATERIALS, ENGINEERING & EMERGING TECHNOLOGY (MEET - 2026)

Hybrid mode

Organized by Department of Electronics
and Communication Engineering

Theme: INTERDISCIPLINARY INNOVATION IN ENGINEERING AND TECHNOLOGY

17th APRIL, 2026 | Seminar Hall



ABOUT THE CONFERENCE:

The International Conference on Recent Trends in Materials, Engineering, and Emerging Technology (IC-MEET 2026) provides an international platform for researchers, academicians, industry professionals, and students to present original research and exchange innovative ideas in the areas of Materials Science, Engineering, and Emerging Technologies.

The conference emphasizes recent advancements in flexible electronics, artificial intelligence and machine learning, biomedical and healthcare technologies, cybersecurity, nanotechnology, and smart systems, with a focus on both theoretical developments and practical applications.

The event aims to promote interdisciplinary collaboration, foster high-quality research, and encourage knowledge dissemination addressing current and future technological challenges.

The theme of the conference, "Interdisciplinary Innovation in Engineering and Technology," promotes the integration of diverse engineering and technological disciplines to address complex real-world challenges. It invites academics, researchers, and industry professionals to share pioneering research and engage in collaborative discussions that bridge fields such as engineering, computer science, materials science, healthcare, and environmental technology.

CALL FOR PAPERS:

Scientists, academicians, researchers, practicing engineers, and students from across the Nation are cordially invited to submit their original research papers and case studies for presentation at the International Conference on MEET - 2026, scheduled to be held on 17th April 2026 at T. John Institute of Technology, Bangalore, India, in both offline and online modes. The conference aims to provide a dynamic platform for participants to share their knowledge, skills, experiences, and expertise through research presentations and keynote addresses on the stated conference themes.

Interested researchers, academicians, and students are requested to submit abstracts of 150-200 words, neatly typed and clearly outlining the methodology, key findings, and conclusions, on any of the listed topics. Selected papers will be published in conference proceedings with an ISBN and in peer-reviewed journals (publication charges applicable).

ADVISORY COMMITTEE:

Dr. Arunmetha S

Associate Dean R& D
Centre for Excellence in Flexible Electronics
Koneru Lakshmaiah Education Foundation,
Andhra Pradesh

Dr. G. Beni

Associate Professor
Department of Computer Science and Engineering
Noorul Islam Centre for Higher Education, Tamil Nadu

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Engineer
Power chip Semiconductor Manufacturing Company,
Taiwan

Dr. Srither Pandey M

Process Engineer
IHI Corporation, New Delhi

Dr. Anusha Thampi V V

Technical Lead
TATA Electronics Pvt., Ltd, Hosur

CALL FOR PAPER/POSTER GUIDELINES:

The research paper can be on the following themes

- **Flexible Electronics**
- **Aerospace, Automotive and Civil Applications**
- **AI & Machine Learning**
- **Communications**
- **Biomedical and Healthcare Diagnostics**
- **IoT, Cyber Security and forensic Science**
- **Pathology and Pharmacology**
- **Nanomaterials and Nanotechnology Applications**
- **Smart Organization: AI based Business Administration**

IMPORTANT KEY DATES:

- **Conference Date:**
17th April 2026

- **Abstract Submission Starts:**
11th February 2026

- **Notification of Acceptance:**
05th March 2026

- **Deadline for Full Paper Submissions:**
20th March 2026

- **Deadline for Camera Ready Submission:**
30th March 2026

REGISTRATION FEE (INCLUDING GST):

- **Rs. 300/-** per participant for UG/PG Students
- **Rs. 500/-** per participant for TJGI Staff
- **Rs. 750/-** per participant for Academician/Research Scholar
- **Rs. 1000/-** per participant from Industry
- **Rs. 650/-** per team for Online Participants

SCAN TO PAY



REGISTRATION QR



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CONTACT:

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